Loader FULL WAFER CONTACT

FOX DiePak[®] Loader

Device Loader/Unloader for FOX DiePak Carriers



PRODUCT BENEFITS

• Automated Solution for Loading and Unloading Modules & Singulated Die

- Loads and unloads devices between JEDEC trays and DiePak carriers
- Handles: QFN, CSP, QFP, TSOP, BGA and EMMC devices
- Contains JEDEC bin trays for device test sorting
- Precision Socket Loading/Unloading
 - Precision alignment ensured with DiePak carrier specific alignment kit designed for handling device to socket alignment and placement in a DiePak carrier

• Production Proven Full-Wafer Burn-in & Test Solution

- Based upon an industry-leading pick and place handler design
- Optical bar code reading of JEDEC tray, DiePak carrier and device IDs for error free operation and device traceability
- Includes a DiePak Trolley for easy loading of DiePak carriers into the FOX-XP system

• Integrated Solution with FOX-XP system

- Enables automated selection of test program based on device/lot ID
- Shares traceability of devices and test results with FOX-XP system

"Setting the Test Standard for Tomorrow"

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